

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHUHEI MITANI	02/02/2014
YUKI NAKANO	01/07/2014
HEIJI WATANABE	02/15/2014
TAKAYOSHI SHIMURA	02/17/2014
TAKUJI HOSOI	02/17/2014
TAKASHI KIRINO	02/21/2014
RECEIVING PARTY DATA	
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City:	KYOTO-SHI, KYOTO
State/Country:	JAPAN
Postal Code:	615-8585
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17464303
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NAME OF SUBMITTER:	BRIAN D. WALKER
SIGNATURE:	/Brian D. Walker, Reg. #37751/
DATE SIGNED:	09/02/2021
Total Attachments: 2	

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ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

Whereas Shuhei MITANI, Yuki NAKANO, Heiji WATANABE, Takayoshi SHIMURA, Takuji HOSOI, and Takashi KIRINO, hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME,

[] said application being attached hereto;

[X] said application having been filed in the United States Patent and Trademark Office on January 7, 2014, as Application Serial No. 14/148,766, and was amended on _____ (if applicable);

[] the specification of which was filed under the Patent Cooperation Treaty on _____, Serial No. _____, the United States of America being designated.

And Whereas ROHM CO., LTD. of 21, Sain Mizosaki-cho, Ukyo-ku, Kyoto-shi, Kyoto 615-8585, Japan, hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

Now This Witnesseth, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

And said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

And said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Address all correspondence and telephone calls to Rabin & Berdo, P.C., 1101 14th Street, N.W., Suite 500, Washington, D.C. 20005. Telephone: (202) 371-8976; Fax: (202) 408-0924, Customer No. 23995.

WITNESS:

Signature: _____

Name: _____

Address: _____

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature: Shuhei Mitani

Legal Name: Shuhei MITANI

Date: February 2, 2014

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WITNESS:

Signature: _____

Name: _____

Address: _____

ASSIGNOR (SECOND INVENTOR):

Signature: Yuki NakanoLegal Name: Yuki NAKANODate: January 7, 2014

WITNESS:

Signature: _____

Name: _____

Address: _____

ASSIGNOR (THIRD INVENTOR):

Signature: Heiji WatanabeLegal Name: Heiji WATANABEDate: February 15, 2014

WITNESS:

Signature: _____

Name: _____

Address: _____

ASSIGNOR (FOURTH INVENTOR):

Signature: Takayoshi ShimuraLegal Name: Takayoshi SHIMURADate: February 17, 2014

WITNESS:

Signature: _____

Name: _____

Address: _____

ASSIGNOR (FIFTH INVENTOR):

Signature: Takuji HosoiLegal Name: Takuji HOSOIDate: February 17, 2014

WITNESS:

Signature: _____

Name: _____

Address: _____

ASSIGNOR (FIFTH INVENTOR):

Signature: Takashi KirinoLegal Name: Takashi KIRINODate: February 21, 2014

RABIN & BERDO, P.C., Washington, D.C.